



BC857BFZ

45V PNP SMALL SIGNAL TRANSISTOR IN DFN0606

Features

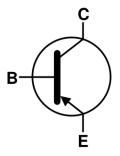
- BV_{CEO} > -45V
- I_C = -100mA High Collector Current
- P_D = 925mW Power Dissipation
- 0.36mm² Package Footprint, 40% Smaller than DFN1006
- 0.4mm Height Package Minimizing Off-Board Profile
- Complementary NPN Type BC847BFZ
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

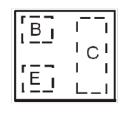
Mechanical Data

- Case: X2-DFN0606-3
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu, Solderable per MIL-STD-202, Method 208 (4)
- Weight: 0.0008 grams (Approximate)









Top View

Bottom View

Device Symbol

Top View Device Schematic

Ordering Information (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
BC857BFZ-7B	3W	7	8	10,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



Top View Bar Denotes Base and Emitter Side 3W = Product Type Marking Code



Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-50	V
Collector-Emitter Voltage	V _{CEO}	-45	V
Emitter-Base Voltage	V _{EBO}	-6.0	V
Continuous Collector Current	Ic	-100	mA
Peak Pulse Collector Current	I _{CM}	-200	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Dower Discipation	(Note 5)		270	- mW	
Power Dissipation	(Note 6)	P _D	925		
Theymal Desistance Innsticute Ambient	(Note 5)		465	°C/W	
Thermal Resistance, Junction to Ambient	(Note 6)	$R_{\theta JA}$	135		
Thermal Resistance, Junction to Lead (Note 7)		$R_{ heta JL}$	135	°C/W	
Operating and Storage and Temperature Rang	T _J , T _{STG}	-55 to +150	°C		

ESD Ratings (Note 8)

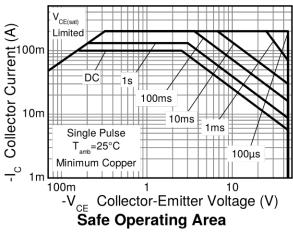
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	٧	3A
Electrostatic Discharge - Machine Model	ESD MM	200	V	В

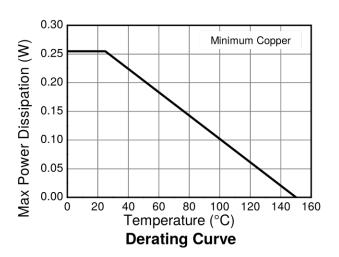
Notes:

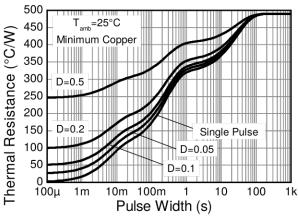
- For the device mounted on minimum recommended pad layout 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady state condition. The entire exposed collector pad is attached to the heatsink.
 Same as Note 5, except the exposed collector pad is mounted on 25mm x 25mm 2oz copper.
 Thermal resistance from junction to solder-point (on the exposed collector pad).
 Refer to JEDEC specification JESD22-A114 and JESD22-A115.

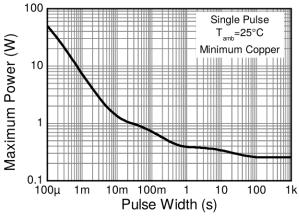


Thermal Characteristics and Derating Information









Transient Thermal Impedance

Pulse Power Dissipation



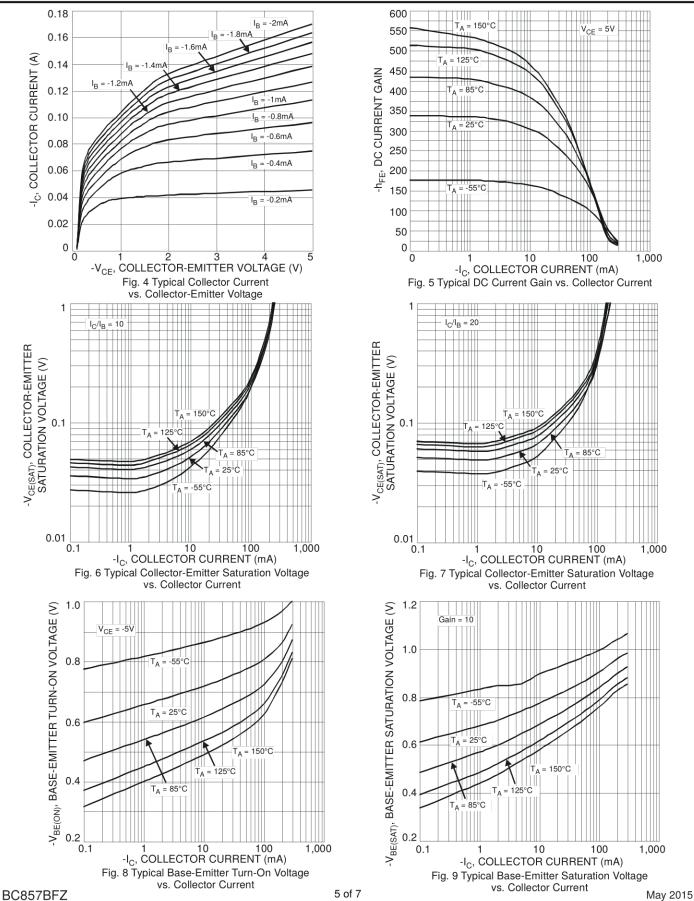
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typical	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV _{CBO}	-50	-100	_	V	$I_C = -50\mu A, I_B = 0$
Collector-Emitter Breakdown Voltage	BV _{CES}	-50	-90	_	V	$I_C = -50\mu A, I_B = 0$
Collector-Emitter Breakdown Voltage (Note 9)	BV _{CEO}	-45	-65	_	V	$I_{C} = -1 \text{mA}, I_{B} = 0$
Collector-Base Breakdown Voltage	BV _{EBO}	-6.0	-8.5	_	V	$I_E = -50\mu A, I_C = 0$
Collector-Base Cutoff Current	I _{CBO}	_	_	-15	nA	V _{CB} = -40V
Collector-Emitter Cutoff Current	I _{CES}	_	_	-15	nA	V _{CE} = -40V
ON CHARACTERISTICS (Note 9)						
DC Current Gain	h _{FE}	_ 200	340 330	— 470	_	$I_C = -10\mu A$, $V_{CE} = -5.0V$ $I_C = -2.0mA$, $V_{CE} = -5.0V$
Collector-Emitter Saturation Voltage	V _{CE(sat)}	_	-70 -300	-175 -500	mV	I _C = -10mA, I _B = -0.5mA I _C = -100mA, I _B = -5.0mA
Base-Emitter Saturation Voltage	V _{BE(sat)}	_	-760 -885	-1,000 -1,100	mV	I _C = -10mA, I _B = -0.5mA I _C = -100mA, I _B = -5.0mA
Base-Emitter Voltage	V _{BE(on)}	-600 —	-670 -715	-780 -850	mV	I _C = -2.0mA, V _{CE} = -5V I _C = -10mA, V _{CE} = -5V
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	Cobo	1	2.0	_	pF	$V_{CB} = -10.0V$, $f = 1.0MHz$, $I_E = 0$
Current Gain-Bandwidth Product	f _T	100	270	_	MHz	V _{CE} = -5V, I _C = -10mA, f = 100MHz

Note: 9. Measured under pulsed conditions. Pulse width $\leq 300 \mu s$. Duty cycle $\leq 2\%$.



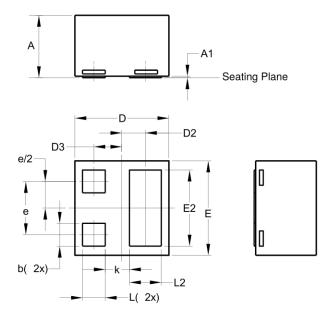
Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)





Package Outline Dimensions

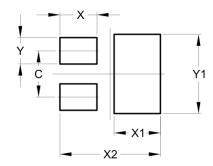
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



X2-DFN0606-3					
Dim	Min	Max	Тур		
Α	0.36	0.42	0.39		
A1	0	0.05	0.02		
b	0.10	0.20	0.15		
D	0.57	0.67	0.62		
D2	0.155 BSC				
D3	0.185 BSC				
E	0.57	0.57 0.67 0.6			
E2	0.40	0.60	0.50		
е	0.35 BSC				
k	0.16 REF				
L	0.09	0.21	0.15		
L2	0.11	0.31	0.21		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.350
Х	0.280
X1	0.350
X2	0.760
Υ	0.200
V1	0.600



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